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	FID1 FID2 FID3				
	PCB Number: TIDA-00620 PCB	DCD			
	PCB Rev: E1	PCB O LOGO Instruments Pb-Free Symbol			
	Texas I	Instruments Pb-Free Symbol			

Label Table			
Variant	Label Text		
001	ChangeMe!		
002	ChangeMe!		

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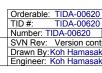
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ZZ2 Assembly Note These assemblies are ESD sensitive, ESD precautions shall be observed.

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ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4 Assembly Note These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



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	specifications, will be suitable for your application				
licensors do not warrant that the desig	n is production worthy. You should completely va	alidate and test your design implementation t	o confirm the system functionality for	r your application.	Eng
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20	Designed for: Public Relea		Date: 10/5/2015	
20	Project Title: 12V to 24V, 2	27A Brushed DC M	otor Reference De	esi Jii T _E
Rev: E1	Sheet Title: System Hardv	vare		
ontrol disabled	Assembly Variant: 001		Sheet: 2 of 2	
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